

TS80002 High-Efficiency Transmit Controller for Wireless Power Systems

POWER MANAGEMENT

Features

- Supports portable wireless charging applications
- Wireless power systems up to 5W
- Integrated controller and FLASH for communications and control
- High precision data converter
- Low external component count
- Product is lead-free, Halogen Free, RoHS / WEEE compliant

Applications

- Low-power wireless chargers for:
 - o Smart Watches
 - Wearables
 - o Toys
 - Portable Lighting
 - Medical Devices

Description

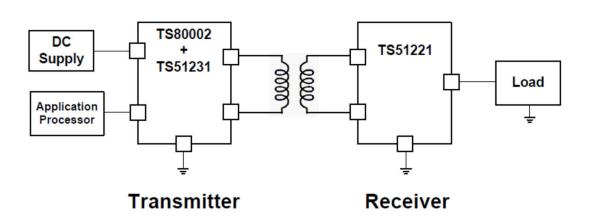
The TS80002 is a power transmitter communications and control unit for wireless charging applications. The TS80002 can support systems up to 5W and proprietary applications.

The TS80002 performs the necessary coding of protocol to send commands to the transmitter to adjust the power level accordingly.

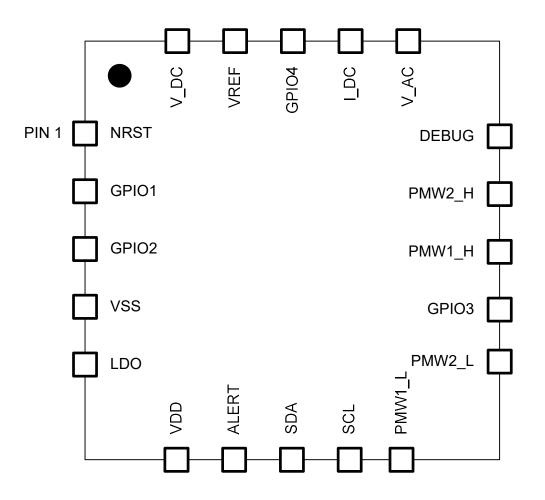
Specifications

- RISC-based controller core with flash and SRAM memory
- 10-bit A/D converter
- Two 16-bit timers, advanced control and general purpose
- 8-bit timer
- Auto-wakeup and watchdog timers
- 4 configurable general purpose IOs
- I2C interface
- 20 pin 3x3 QFN

Typical Application Circuit



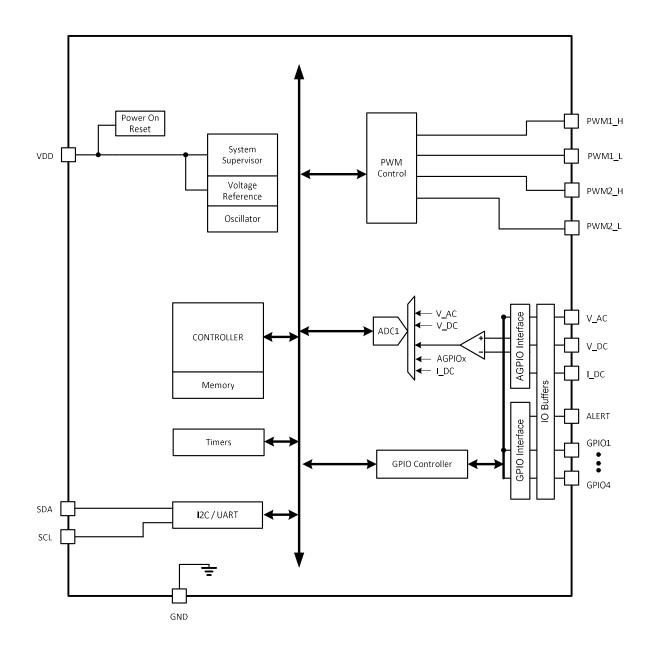
Pinout (Top View)



Pin Description

QFN Pin #	Pin Symbol	Function	Description
1	NRST	Reset	Reset input
2	GPIO1	GPIO	GPIO 1
3	GPIO2	GPIO	GPIO 2
4	VSS	Power GND	Power GND
5	LDO	Filter	Internal LDO filter capacitor
6	VDD	Input power	Input power supply
7	ALERT	I2C Alert	I2C Alert signal
8	SDA	I2C Serial Data	I2C Serial Data
9	SCL	I2C Serial Clock	I2C Serial Clock
10	PWM1_L	PWM output	PWM1 low-side control
11	PWM2_L	PWM output	PWM2 low-side control
12	GPIO3	GPIO	GPIO 3
13	PWM1_H	PWM	PWM1 high-side control
14	PWM2_H	PWM	PWM2 high-side control
15	DEBUG	Debug	Debug interface
16	V_AC	Analog GPIO	AC voltage measurement
17	I_DC	Analog GPIO DC current measurement	
18	GPIO4	GPIO GPIO 4	
19	VREF	Analog GPIO	Voltage reference input
20	V_DC	Analog GPIO	DC voltage measurement

Functional Block Diagram



Absolute Maximum Ratings

Over operating free–air temperature range unless otherwise noted ^(1, 2, 3)	

Parameter	Min	Max	Unit
VDD, VSS	-0.3	6.5	V
GPIO1, GPIO2, VSS, VDD, ALERT, SDA, SCL, PWM1_L, PWM2_L, GPIO3, PWM1_H, PWM2_H, DEBUG, V_AC, I_DC, GPIO4, VREF, V_DC	VSS - 0.3	6.5	V
NRST, LDO	VSS - 0.3	VDD + 0.3	V
Operating Junction Temperature Range, T _J	-40	125	٥°
Storage Temperature Range, Tstg	-65	150	٥C
Electrostatic Discharge – Human Body Model		±2k	V
IR reflow temperature (soldering, 10 seconds)		260	٥C

Notes:

- (1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute–maximum– rated conditions for extended periods may affect device reliability.
- (2) All voltage values are with respect to network ground terminal.
- (3) ESD testing is performed according to the respective JESD22 JEDEC standard.

Recommended Operating Conditions

Symbol	Parameter	Min	Тур	Max	Unit
VDD	Input Operating Voltage	2.95		5.5	V
Fмcu	Operating Frequency	0		16	MHz
VDD	Decoupling capacitor value		1		uF
LDO	Decoupling capacitor value		1		uF
TA	Operating Free Air Temperature	-40		85	°C
TJ	Operating Junction Temperature	-40		105	°C

Communication Interfaces

The Applications Processor can interrogate the TS80002 using the I2C interface. The TS80002 acknowledges its I2C Slave Address only if it is powered. No ACK from the TS80002 after its slave address means that power is not applied to the TS80002.

I2C

I2C Signal Pins

ALERT pin (GPIO pin) - optional:

- Driven high when an event is active in the internal STATUS register
- Driven low when all the internal events are cleared

Note: The ALERT pin is provided to help with I2C communication, i.e. to signal events to the EC so the EC can interrogate the TS80002 via I2C. The use of the ALERT pin is not mandatory in the application.

SCL pin:

- Clock pin for the I2C interface.
- True open-drain. Needs external pull-ups.

SDA pin:

- Data pin for the I2C interface.
- True open-drain. Needs external pull-ups.

I2C Protocol

The TS80002 Wireless Power Receiver acts as an I2C slave peripheral to allow communication with an application microcontroller. The slave address (7 bit) is 0x49. The Embedded Controller is an I2C master and initiates every data transfer.

The TS80002 implements a set of registers available from the I2C bus. It also implements a set of API functions that receive parameters and return values using the I2C bus. Four transfer types are possible:

- Write Register
- Read Register
- Run API Function
- Read API Function Return Buffer

Write Register Operations

Description

START		Start of the I2C transfer.		
M→S	Slave Address (7 bits) 0 (1 bit)	Slave ACK	Slave address + R/W bit (0x92 as 8-bit).	
M→S	Register <i>n</i> address (8 bits)	Address of the first register.		
M→S	Register <i>n</i> Data (8 bits)	Slave ACK	Write the first register.	
M→S	Register <i>n</i> +1 Data (8 bits)	Slave ACK	Optionally write the following registers.	
M→S	Register <i>n+k</i> Data (8 bits)	Slave ACK		
STOP			Stop of the I2C transfer.	

Read Register Operations

Description

START			Start of the I2C transfer.		
M→S	Slave Address (7 bits) 0 (1 bit)	Slave ACK	Slave address + 0 as R/W bit (0x92 as 8-bit).		
M→S	Register <i>n</i> address (8 bits)	Slave ACK	Address of the first register.		
START		Repeated Start.			
M→S	Slave Address (7 bits) 1 (1 bit)	Slave ACK	Slave address + 1 as R/W bit (0x93 as 8-bit).		
S→M	Register <i>n</i> Data (8 bits)	Master ACK	Read the first register.		
S→M	Register <i>n</i> +1 Data (8 bits)	Master ACK	Optionally read the following registers.		
S→M	Register <i>n+k</i> Data (8 bits)	Master	The master should send a nACK after the last		
	nAC		data byte was received.		
STOP		Stop of the I2C transfer			

Run API Function

Description

Start			Start of the I2C transfer.		
M→S	Slave Address (7 bits) 0 (1 bit)	Slave ACK	Slave address + R/W bit (0x92 as 8-bit).		
M→S	API number (8 bits)	Slave ACK	API number.		
M→S	API input buffer length <i>m</i> (8 bits)	Slave ACK	API input buffer length. Equal to 0 if no input buffer data is required by the API.		
M→S	Input buffer data[0] (8 bits)	Slave ACK	First byte of the input buffer (optional).		
M→S	Input buffer data[1] (8 bits)	Slave ACK	Second byte of the input buffer (optional).		
M→S	Input buffer data[<i>m</i> -1] (8 bits)	Slave ACK	Last byte of the input buffer (optional).		
Stop			Stop of the I2C transfer and execute the API function.		

Read API Function Return Buffer

Description

START				Start of the I2C transfer.		
M→S	Slave Address (7 bits)	0 (1 bit)	Slave ACK	Slave address + 0 as R/W bit (0x92 as 8-bit).		
M→S	API number (8 bits)		Slave ACK	API number.		
START		Repeated Start.				
M→S	Slave Address (7 bits)	1 (1 bit)	Slave ACK	Slave address + 1 as R/nW bit (0x93 as 8- bit).		
S→M	API number (8 bits)		Master ACK	API number for the following return buffer.		
S→M	API return buffer length n	(8 bits)	Master ACK	API return buffer length.		
S→M	Output buffer data[0] (8 bi	ts)	Master ACK	Read the first byte in the output buffer.		
S→M	Output buffer data[1] (8 bi	ts)	Master ACK	Optionally read the following bytes.		
S→M	Output buffer data[n-1] (8 bits)		Master	The master should send a nACK after the last		
	nACK			data byte was received.		
STOP	STOP			Stop of the I2C transfer		

Internal Registers

Address	Name	Туре	Description
0x00	BOOTFW_REV_L	R/W	Bootloader Firmware Revision Low Register
0x01	BOOTFW_REV_H	R/W	Bootloader Firmware Revision High Register
0x02	FW_REV_L	R/W	Firmware Revision Low Register
0x03	FW_REV_H	R/W	Firmware Revision High Register
0x04	MODE_L	R/W	Operating Mode Low Register
0x05	MODE_H	R/W	Operating Mode High Register
0x06	RESET_L	R/W	Reset Low Register
0x07	RESET_H	R/W	Reset High Register
0x08	STATUS	R	Main Status Register
0x09	STATUS0	R	Status0 Register
0x0A	STATUS1	R	Status1 Register
0x0B	STATUS2	R	Status2 Register
0x0C	STATUS3	R	Status3 Register
0x0D-0x7F	RESERVED. Will be	e defined lat	er.

Bootloader Firmware Revision Low Register (BOOTFW_REV_L)

Address: 0x00

Minor version number of the bootloader firmware Reset value:

7	6	5	4	3	2	1	0		
	REV_L[7:0]								
r	r r r r r r r								

Bits 7:0 REV_L[7:0]: Bootloader Firmware Revision Low

These bits contain the minor version number of the bootloader firmware.

Bootloader Firmware Revision High Register (BOOTFW_REV_H)

Address: 0x01

Reset value: Major version number of the bootloader firmware

7	6	5	4	3	2	1	0	
	REV_H[7:0]							
r	r	r	r	r	r	r	r	

Bits 7:0 **REV_H[7:0]**: Bootloader Firmware Revision High

These bits contain the major version number of the bootloader firmware.

Firmware Revision Low Register (FW_REV_L) 0x02

Address:

Minor version number of the user firmware Reset value:

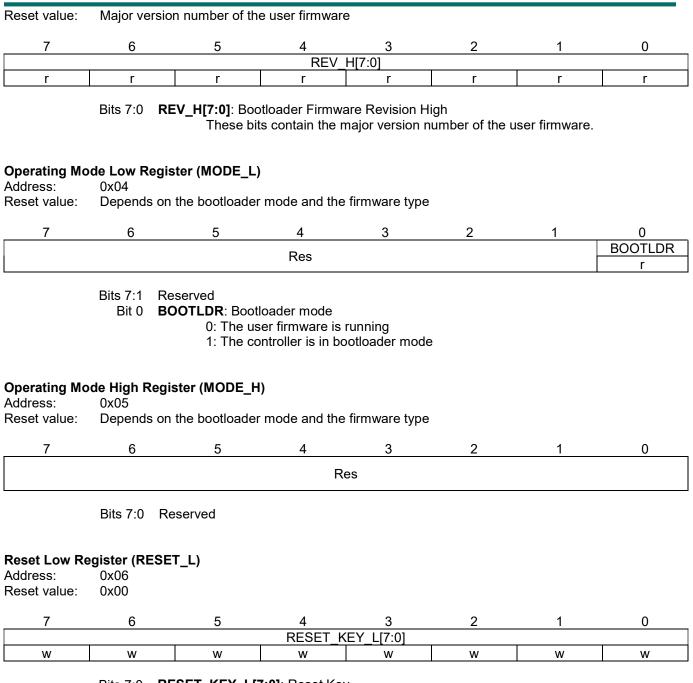
7	6	5	4	3	2	1	0		
	REV_L[7:0]								
							r		

Bits 7:0 REV_L[7:0]: Firmware Revision Low

These bits contain the minor version number of the user firmware.

Firmware Revision High Register (BOOTFW_REV_H)

Address: 0x03



Bits 7:0 RESET_KEY_L[7:0]: Reset Key

0x55: generate a system reset. Both the RESET_L and the RESET_H registers have to be written with the correct key to generate a reset. Any other value: a system reset is not generated.

Reset High Register (RESET_H)

	Address: Reset value:	0x07 0x00						
_	7	6	5	4	3	2	1	0
	RESET_KEY_H[7:0]							
	W	W	W	W	W	W	W	W

Bits 7:0 RESET_KEY_H[7:0]: Reset Key

0xAA: generate a system reset. Both the RESET_L and the RESET_H registers have to be written with the correct key to generate a reset. Any other value: a system reset is not generated.

Main Status Register (STATUS)

Address:	0x08
Reset value:	0xC0

7	6	5	4	3	2	1	0
CTS	CTS_API	D		STATUS3	STATUS2	STATUS1	STATUS0
rw	rw	Re	25	rw	rw	rw	rw

Bit 7 **CTS**: Clear To Send

This bit indicates if a new command can be issued to the controller.

0: The controller is busy processing a previous command. New commands should not be sent to the controller.

- 1: The controller can accept a new command over the communication interface.
- Bit 6 CTS_API: Clear to Send for API

This bit indicates if a new API call can be issued to the controller.

0: The controller is busy processing a previous API call. New API calls should not be sent to the controller.

- 1: The controller can accept a new API call over the communication interface.
- Bits 5:4 Reserved
 - Bit 3 STATUS3: STATUS3 Event Flag
 - 0: No event is signaled in the STATUS3 register
 - 1: An event is signaled in the STATUS3 register
 - Bit 2 **STATUS2**: STATUS2 Event Flag
 - 0: No event is signaled in the STATUS2 register
 - 1: An event is signaled in the STATUS2 register
 - Bit 1 STATUS1: STATUS1 Event Flag
 - 0: No event is signaled in the STATUS1 register
 - 1: An event is signaled in the STATUS1 register
 - Bit 0 **STATUS0**: STATUS0 Event Flag
 - 0: No event is signaled in the STATUS0 register
 - 1: An event is signaled in the STATUS0 register

API Functions

API Number	API Name	Description
0x80	BOOTLOADER_UNLOCK_FLASH	Allow changes to the FLASH memory
0x81	BOOTLOADER_WRITE_BLOCK	Write a page into the FLASH memory
0x82	BOOTLOADER_CRC_CHECK	Check the CRC of the user firmware
0x83-0xFE	RESERVED. Will be defined later.	
0xFF	API_ERROR	Value returned in the API field when a Read API
		Function Return Buffer command is issued and the API
		function called previously has generated an error.

Bootloader Unlock Flash (BOOTLOADER_UNLOCK_FLASH)

API number:	0x80	
Input buffer size:		TBD
Output buffer size:	1	

Buffer	Parameter	Length (bytes)	Description
Input buffer	TBD		
Return data buffer	ERROR_CODE	1	

Bootloader Write Block (BOOTLOADER_WRITE_BLOCK)

API number:	0x81	
Input buffer size:		66
Output buffer size:	1	

Buffer	Parameter	Length (bytes)	Description
Input buffer	Block Number Block Data	2 64	Block index. The first block has an index of 0. Data to be written to the FLASH page.
Return data buffer	ERROR_CODE	1	

Bootloader CRC Check (BOOTLOADER_CRC_CHECK)

API number:0x82Input buffer size:0Output buffer size:1

Buffer	Parameter	Length (bytes)	Description
Return data buffer	ERROR_CODE	1	

API ERROR CODES

Error Code	Error Code Name	Description
0x00	ERROR_GENERIC	Generic error.
0x01	ERROR_OK	Operation succeeded. This is not indicating an error.
0x02	ERROR_INVALID_CRC	CRC error.
0x03	ERROR_FLASH_UNLOCK_FAILED	FLASH unlocking has failed.
0x04	ERROR_API_NOT_IMPLEMENTED	The API number is not implemented.
0x05	ERROR_API_DATA_OVERFLOW	The API input buffer has been filled with more data than its length.
0x06	ERROR_API_INVALID_PARAMETERS	•

Application Schematic

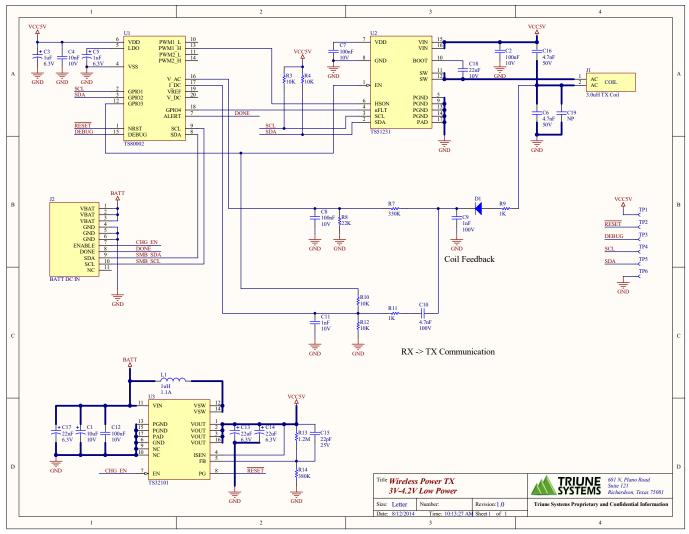
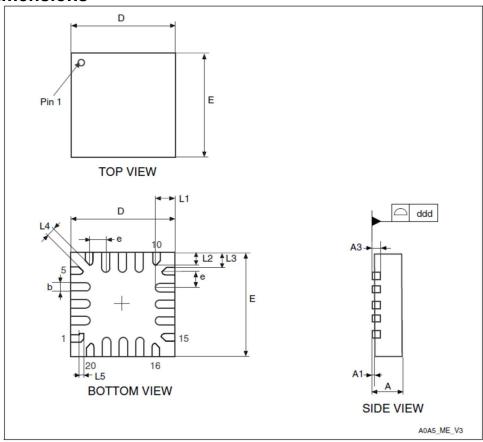


Figure 1: TS80002 Application Schematic

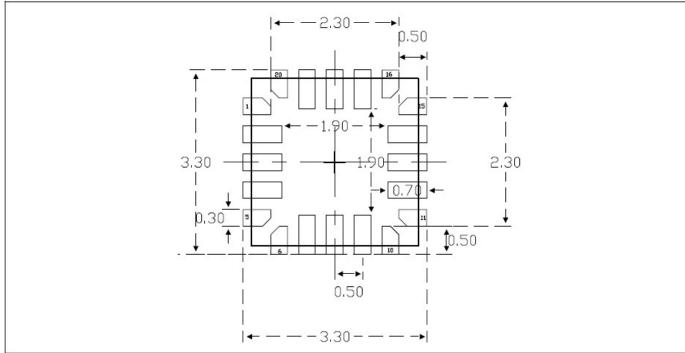
Package Dimensions



20-lead ultra thin fine pitch quad flat no-lead package outline (3x3)* *drawing not to scale

0	millimeters			inches		
Symbol	Min	Тур	Max	Min	Тур	Max
A	0.500	0.550	0.600	0.0197	0.02 <mark>1</mark> 7	0.0236
A1	0.000	0.020	0.050	0.0000	0.0008	0.0020
A3	-	0.152	-	(1)	0.060	-
D	-	3.000	÷	14	0. <mark>118</mark> 1	-
E	-	3.000	÷		0.1181	-
L1	0.500	0.550	0.600	0.0197	0.0217	0.0236
L2	0.300	0.350	0.400	0.0118	0.0138	0.0 <mark>1</mark> 57
L3	121	0.375			0.0148	
L4	121	0.200			0.0079	
L5	120	0. <mark>1</mark> 50	8		0.0059	
b	0.180	0.250	0.300	0.0071	0.0098	0.0118
e	17.0	0.500		255	0.0197	5
ddd		5	0.050	2 255	-	0.0020

20-lead ultra thin fine pitch	quad flat no-lead	package mechanical data
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20-lead ultra thin fine pitch quad flat no-lead package recommended footprint

Dimensions are expressed in millimeters

QFN Package (Top Marking)

	S	0	3	3
	s	s	L	L
	D	W	W	Y
o				

Legend:

Legend.		
Line 1 Marking:	S033	Internal part code
Line 2 Marking:	SS	Assembly site identifier
	LL	Lot trace code
Line 3 Marking:	D	Assembly year
	WW	Assembly week
	Υ	Additional marking
	0	Pin 1 Identifier

Ordering Information

Device Part Number	Description
TS80002-QFNR	1W, 1MHz switching

RoHS and Reach Compliance

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- Hydrochlorofluorocarbons (HCFCs)
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- Polybrominated Diphenyl Ethers (PBDEs)



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